



40V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

| BV _{DSS} | R _{DS(on)} Max | I _D T _C = +25°C |
|-------------------|--------------------------------|------------------------------------------|
| 40V | 6.5mΩ @ V _{GS} = 10V | 85A |
| | 9.8mΩ @ V _{GS} = 4.5V | 70A |

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Thermally Efficient Package Cooler Running Applications
- High Conversion Efficiency
- Low R_{DS(on)} Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- <1.1mm Package Profile Ideal for Thin Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH4007LPSQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Description and Applications

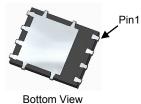
This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

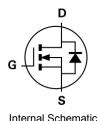
- Motor Controls
- DC-DC Converters
- Load Switches

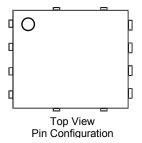
Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)









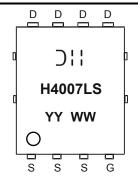
Ordering Information (Note 4)

| Part Number | Case | Packaging |
|-----------------|---------------|-------------------|
| DMTH4007LPSQ-13 | PowerDI5060-8 | 2.500/Tape & Reel |

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



PowerDI5060-8

☐ : = Manufacturer's Marking H4007LS = Product Type Marking Code YYWW = Date Code Marking YY = Last Digit of Year (ex: 21 = 2021) WW = Week Code (01 to 53)

July 2021



Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

| Characteristic | | | Symbol | Value | Units |
|-----------------------------------------------------------------------|--|---------------------------------------------------|------------------|----------|-------|
| Drain-Source Voltage | | | V _{DSS} | 40 | V |
| Gate-Source Voltage | | | V _{GSS} | ±20 | V |
| II Continuous Drain Current Voc = 10V (Note 5) | | T _A = +25°C T _A = +100°C | I _D | 15 11 | А |
| Continuous Drain Current, V _{GS} = 10V (Note 6) Steady State | | T _C = +25°C T _C = +100°C | I _D | 85 60 | А |
| Maximum Continuous Body Diode Forward Current (Note 6) | | | I _S | 85 | А |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | | | I _{DM} | 340 | Α |
| Avalanche Current, L = 0.1mH | | | I _{AS} | 20 | А |
| Avalanche Energy, L = 0.1mH | | | E _{AS} | 20 | mJ |

Thermal Characteristics

| Characteristic | | Symbol | Value | Units |
|--------------------------------------------------|------------------------|-----------------------------------|-------------|-------|
| Total Power Dissipation (Note 5) | T _A = +25°C | P _D | 2.7 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State | $R_{\theta JA}$ | 55 | °C/W |
| Total Power Dissipation (Note 6) | T _C = +25°C | P _D | 83.3 | W |
| Thermal Resistance, Junction to Case (Note 6) | | ReJC | 1.8 | °C/W |
| Operating and Storage Temperature Range | | T _J , T _{STG} | -55 to +175 | °C |

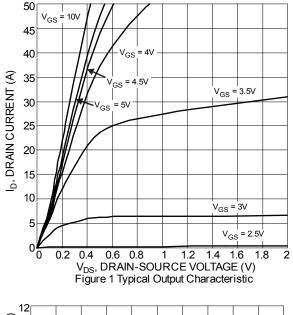
Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

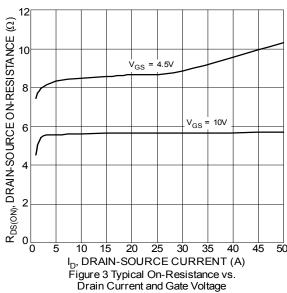
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|--------------------------------------------|---------------------|-----|-------|------|-------|--------------------------------------------------------------|--|
| OFF CHARACTERISTICS (Note 7) | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 40 | _ | _ | V | $V_{GS} = 0V$, $I_D = 1mA$ | |
| Zero Gate Voltage Drain Current | I _{DSS} | _ | | 1 | μA | V _{DS} = 32V, V _{GS} = 0V | |
| Gate-Source Leakage | I _{GSS} | _ | | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 7) | | | • | • | | • | |
| Gate Threshold Voltage | $V_{GS(th)}$ | 1 | _ | 3 | V | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | |
| Static Drain-Source On-Resistance | 0 | _ | 5.4 | 6.5 | mΩ | V _{GS} = 10V, I _D = 20A | |
| Static Drain-Source On-Resistance | R _{DS(on)} | _ | 8.4 | 9.8 | 11177 | V _{GS} = 4.5V, I _D = 20A | |
| Diode Forward Voltage | V_{SD} | _ | _ | 1.2 | V | V _{GS} = 0V, I _S = 20A | |
| DYNAMIC CHARACTERISTICS (Note 8) | • | | • | | | | |
| Input Capacitance | Ciss | _ | 1,895 | _ | | V _{DS} = 30V, V _{GS} = 0V, f = 1MHz | |
| Output Capacitance | Coss | _ | 485 | _ | pF | | |
| Reverse Transfer Capacitance | C _{rss} | _ | 20.9 | _ | | | |
| Gate Resistance | Rg | 0.1 | 0.62 | 1.8 | Ω | $V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$ | |
| Total Gate Charge (V _{GS} = 4.5V) | Qg | _ | 12.4 | _ | | | |
| Total Gate Charge (V _{GS} = 10V) | Qg | _ | 29.1 | _ | | V 201/ 1 201 | |
| Gate-Source Charge | Q _{gs} | _ | 5.9 | _ | nC | $V_{DS} = 30V, I_{D} = 20A$ | |
| Gate-Drain Charge | Q_{gd} | _ | 3.5 | _ | | | |
| Turn-On Delay Time | t _{D(on)} | _ | 5.4 | _ | | $V_{DD} = 30V, V_{GS} = 10V,$ $I_{D} = 20A, R_{G} = 3\Omega$ | |
| Turn-On Rise Time | t_R | _ | 4.5 | _ | | | |
| Turn-Off Delay Time | t _{D(off)} | _ | 16.2 | _ | ns | | |
| Turn-Off Fall Time | t _F | _ | 3.5 | _ | | | |
| Body Diode Reverse Recovery Time | t _{RR} | _ | 30.6 | _ | ns | IF - 200 di/dt - 4000/us | |
| Body Diode Reverse Recovery Charge | Q_{RR} | _ | 28.1 | _ | nC | - IF = 20A, di/dt = 100A/μs | |

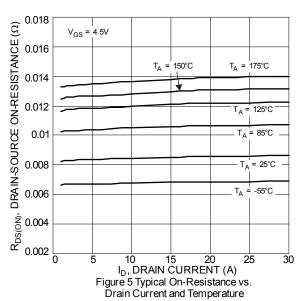
5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate. Notes:

6. Thermal resistance from junction to soldering point (on the exposed drain pad).7. Short duration pulse test used to minimize self-heating effect.8. Guaranteed by design. Not subject to product testing.

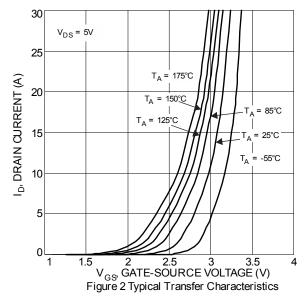


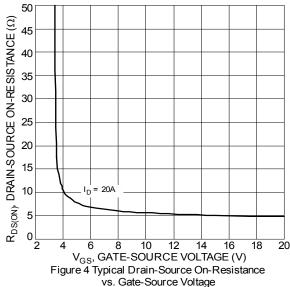


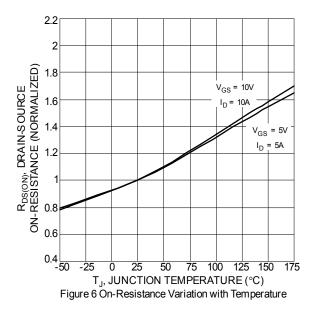




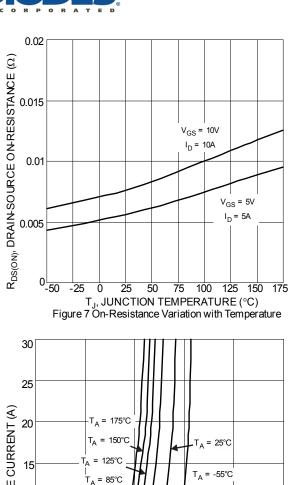
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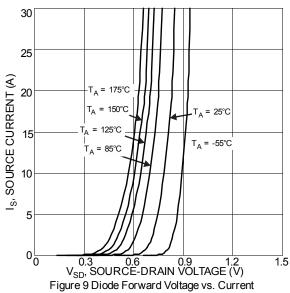


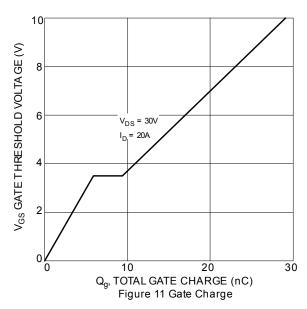


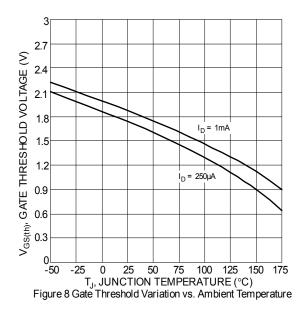


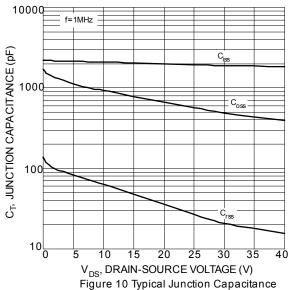


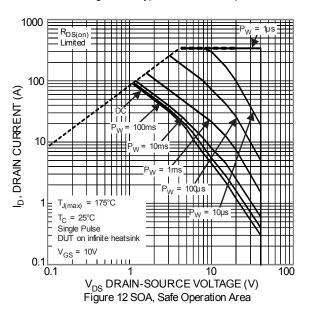




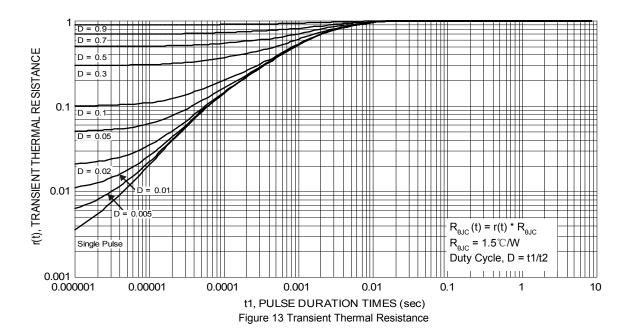










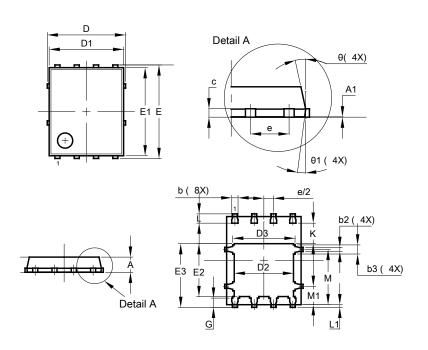




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8

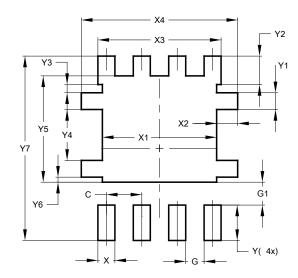


| PowerDI5060-8 | | | | | |
|----------------------|----------------|----------|-------|--|--|
| Dim | Min | Max | Тур | | |
| Α | 0.90 | 1.10 | 1.00 | | |
| A 1 | 0.00 | 0.05 | - | | |
| b | 0.33 | 0.51 | 0.41 | | |
| b2 | 0.200 | 0.350 | 0.273 | | |
| b3 | 0.40 | 0.80 | 0.60 | | |
| С | 0.230 | 0.330 | 0.277 | | |
| D | ; | 5.15 BSC | , | | |
| D1 | 4.70 5.10 4.90 | | | | |
| D2 | 3.70 | 4.10 | 3.90 | | |
| D3 | 3.90 4.30 4.1 | | | | |
| Е | (| 6.15 BSC | , | | |
| E1 | 5.60 | 0 6.00 5 | | | |
| E2 | 3.28 3.68 3.4 | | | | |
| E3 | 3.99 4.39 4.19 | | | | |
| е | | 1.27 BSC | ; | | |
| G | 0.51 | 0.71 | 0.61 | | |
| K | 0.51 | _ | - | | |
| L | 0.51 | 0.71 | 0.61 | | |
| L1 | 0.100 | 0.200 | 0.175 | | |
| M | 3.235 | 4.035 | 3.635 | | |
| M1 | 1.00 | 1.40 | 1.21 | | |
| Θ | 10° | 12° | 11° | | |
| Θ1 | 6° | 8° | 7° | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8



| Dimensions | Value (in mm) | | | |
|------------|---------------|--|--|--|
| С | 1.270 | | | |
| G | 0.660 | | | |
| G1 | 0.820 | | | |
| X | 0.610 | | | |
| X1 | 4.100 | | | |
| X2 | 0.755 | | | |
| Х3 | 4.420 | | | |
| X4 | 5.610 | | | |
| Υ | 1.270 | | | |
| Y1 | 0.600 | | | |
| Y2 | 1.020 | | | |
| Y3 | 0.295 | | | |
| Y4 | 1.825 | | | |
| Y5 | 3.810 | | | |
| Y6 | 0.180 | | | |
| Y7 | 6.610 | | | |



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